

DATA SHEET

SMP1320 Series: Low Resistance, Low Capacitance, Plastic Packaged PIN Diodes

Applications

- High-volume wireless applications

Features

- Resistance: 0.75 Ω typical @ 10 mA
- Capacitance: 0.23 pF typical @ 30 V
- Packages rated MSL1, 260 °C per JEDEC J-STD-020)



Skyworks Green™ products are compliant with all applicable legislation and are halogen-free. For additional information, refer to *Skyworks Definition of Green™*, document number SQ04-0074.



Description

The SMP1320 series of plastic packaged, surface mountable PIN diodes is designed for use in high volume switch applications from 10 MHz to more than 10 GHz. The low current performance of these diodes (0.9 Ω maximum at 10 mA and 2 Ω typical at 1 mA) makes the SMP1320 series particularly suited to battery operated circuits.

The SMP1320 series is available in a selection of plastic packages and a variety of configurations that include an SC-70, a small footprint SC-79, and a miniature SOD-882. Table 1 describes the various packages and markings of the SMP1320 series.

Table 1. SMP1320 Series Packaging and Marking

				
Series Pair	Low Inductance	Single	Single	Single
SC-70	SC-70	SOD-323 Green™	SC-79 Green™	SOD-882 Green™
SMP1320-075LF Green™ Marking: RL2	SMP1320-077LF Green™ Marking: RLB	SMP1320-011LF Marking: RL	◆SMP1320-079LF Marking: Cathode and C5	SMP1320-040LF Marking: N
L _S = 1.4 nH	L _S = 0.4 nH	L _S = 1.5 nH	L _S = 0.7 nH	L _S = 0.45 nH



The Pb-free symbol or "LF" in the part number denotes a lead-free, RoHS-compliant package unless otherwise noted as Green™. Tin/lead (Sn/Pb) packaging is not recommended for new designs.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SMP1320 series are provided in Table 2. Electrical specifications are provided in Table 3. Resistance versus temperature measurements are provided in Table 4.

Typical performance characteristics of the SMP1320 series are illustrated in Figures 1 to 4. Package dimensions are shown in Figures 5 to 11 (odd numbers), and tape and reel dimensions are provided in Figures 6 to 12 (even numbers).

Package and Handling Information

Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SMP1320 series is rated to Moisture Sensitivity Level 1 (MSL1) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, *Solder Reflow Information*, document number 200164.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

Table 2. SMP1320 Series Absolute Maximum Ratings (Note 1)

Parameter	Symbol	Minimum	Maximum	Units
Reverse voltage	V_R		50	V
Power dissipation @ 25 °C lead temperature	P_D		250	mW
Storage temperature	T_{STG}	-65	+150	°C
Operating temperature	T_A	-65	+150	°C
Electrostatic discharge:	ESD			
Charged Device Model (CDM), Class 4			1000	V
Human Body Model (HBM), Class 2			2000	V
Machine Model (MM), Class B			200	V

Note 1: Exposure to maximum rating conditions for extended periods may reduce device reliability. There is no damage to device with only one parameter set at the limit and all other parameters set at or below their nominal value. Exceeding any of the limits listed here may result in permanent damage to the device.

CAUTION: Although this device is designed to be as robust as possible, electrostatic discharge (ESD) can damage this device. This device must be protected at all times from ESD. Static charges may easily produce potentials of several kilovolts on the human body or equipment, which can discharge without detection. Industry-standard ESD precautions should be used at all times.

Table 3. SMP1320 Series Electrical Specifications (Note 1)
($T_A = +25\text{ °C}$, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typical	Max	Units
Reverse current	I_R	$V_R = 50\text{ V}$			10	μA
Capacitance (Note 2)	C_T	$F = 1\text{ MHz}, V = 30\text{ V}$		0.23	0.30	pF
Resistance	R_S	$F = 100\text{ MHz}$ $I = 1\text{ mA}$ $I = 10\text{ mA}$		2.00 0.75	0.90	Ω Ω
Forward voltage	V_F	$I_F = 10\text{ mA}$		0.85		V
Carrier lifetime	τ_I	$I_F = 10\text{ mA}$		0.4		μs
I region width				8		μm

Note 1: Performance is guaranteed only under the conditions listed in this table.

Note 2: C_T @ 30 V is 0.45 pF maximum for the SMP1320-077LF.

Table 4. Resistance vs Temperature @ 500 MHz

I_F (mA)	R_S @ -55 °C (Ω)	R_S @ -15 °C (Ω)	R_S @ +25 °C (Ω)	R_S @ +65 °C (Ω)	R_S @ +100 °C (Ω)
0.02	29.6	29.2	30.8	32.0	32.7
0.10	7.2	7.7	8.3	8.8	8.8
0.3	3.4	3.6	3.8	4.0	4.1
0.5	2.5	2.7	2.8	2.9	3.0
1.0	1.7	1.8	1.9	2.0	1.9
10	0.84	0.85	0.76	0.76	0.67
20	0.73	0.73	0.64	0.64	0.56
100	0.59	0.57	0.47	0.48	0.40

Typical Performance Characteristics

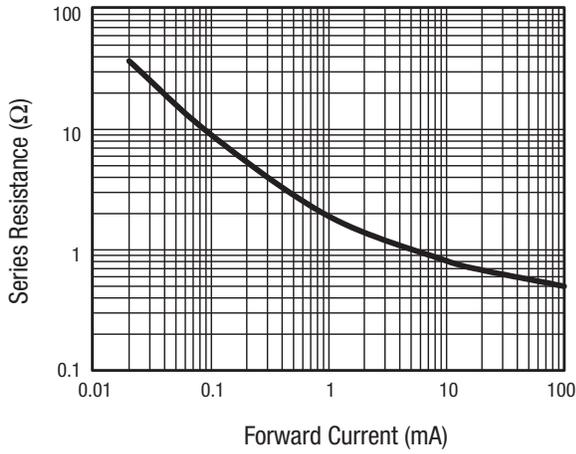


Figure 1. Series Resistance vs Current @ 100 MHz

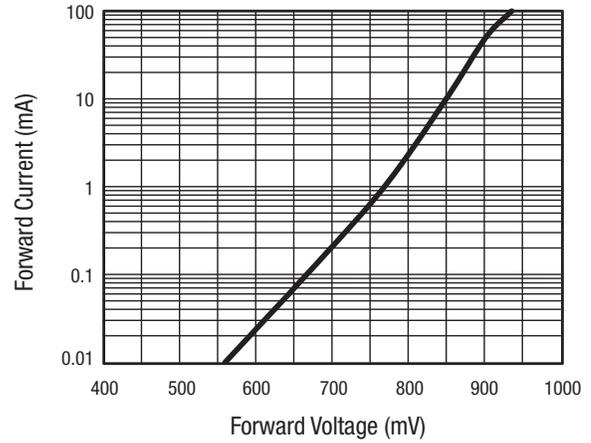


Figure 2. DC Characteristics

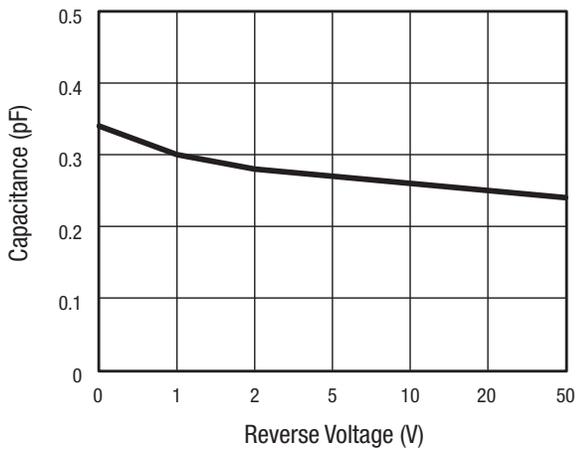


Figure 3. Capacitance vs Reverse Voltage (1 MHz to 1 GHz)

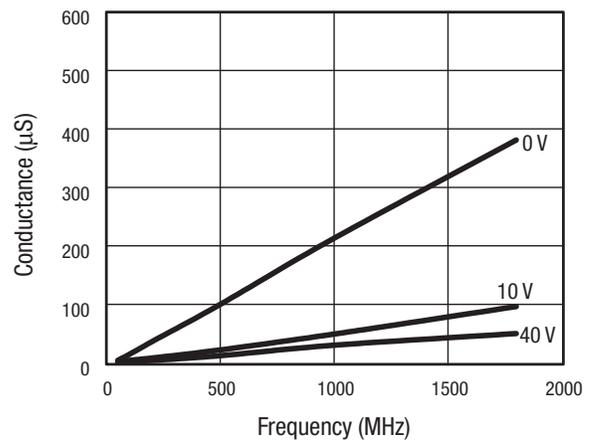


Figure 4. Conductance vs Frequency and Reverse Voltage

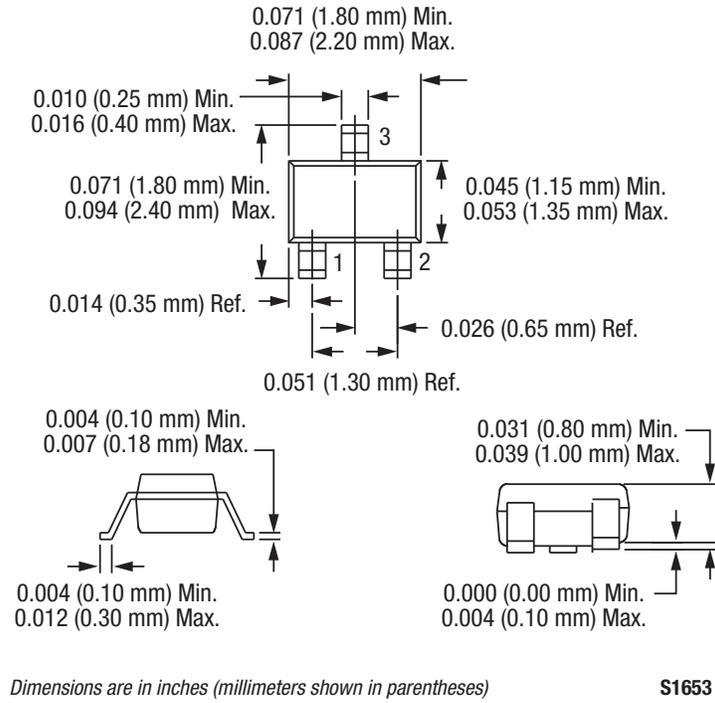
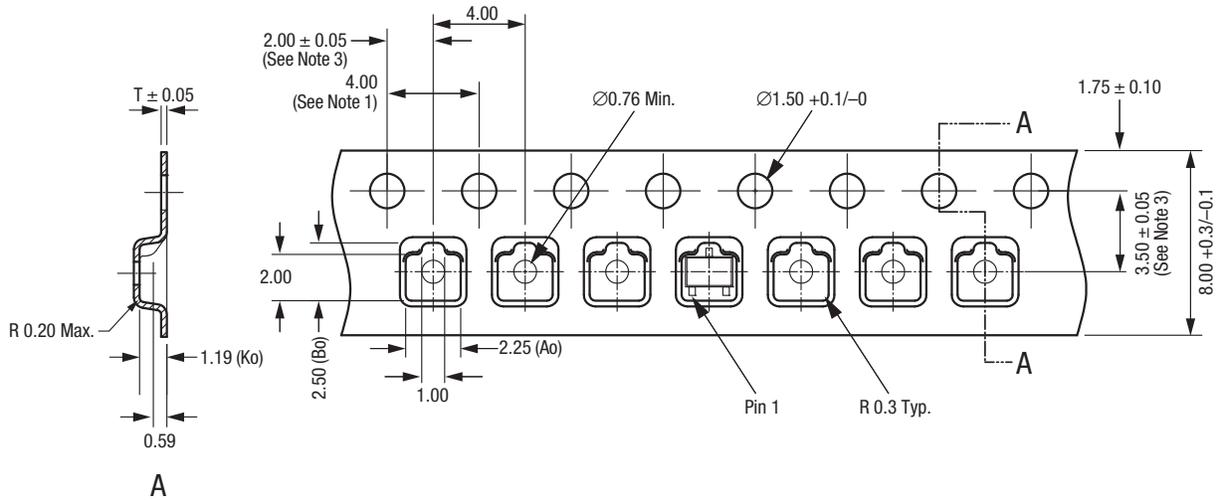
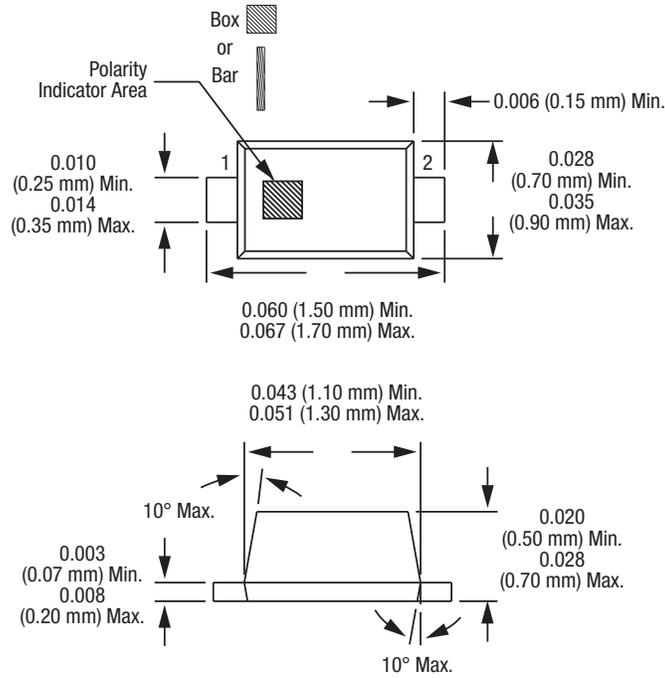


Figure 5. SC-70 Package Dimension Drawing



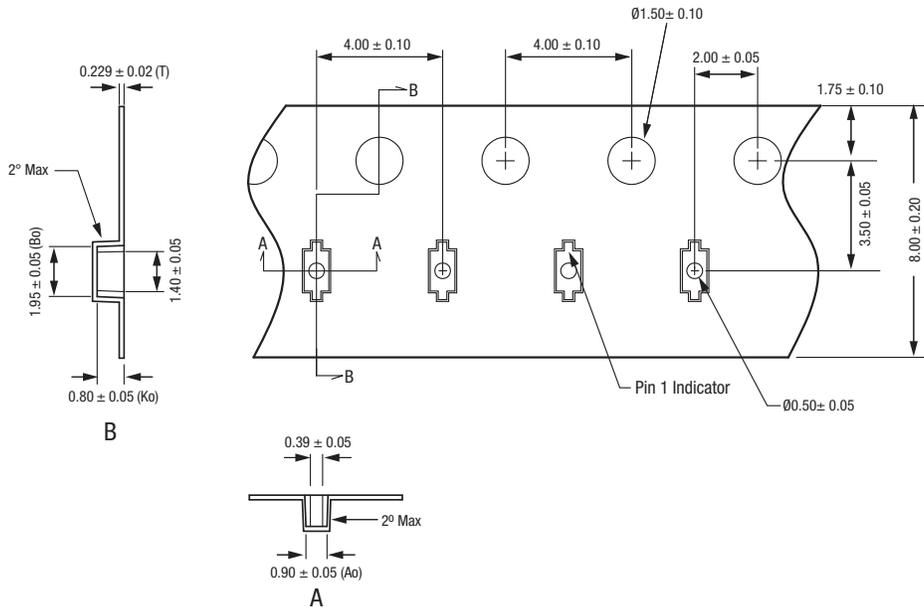
- Notes:
1. Sprocket hole pitch cumulative tolerance ± 0.2 .
 2. Carrier tape: black conductive polystyrene.
 3. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.
 4. Cover tape material: transparent conductive PSA with 9.2 mm width.
 5. All measurements are in millimeters.
- S1685c

Figure 6. SC-70 Tape and Reel Dimensions



Dimensions are in inches (millimeters shown in parentheses) S1652

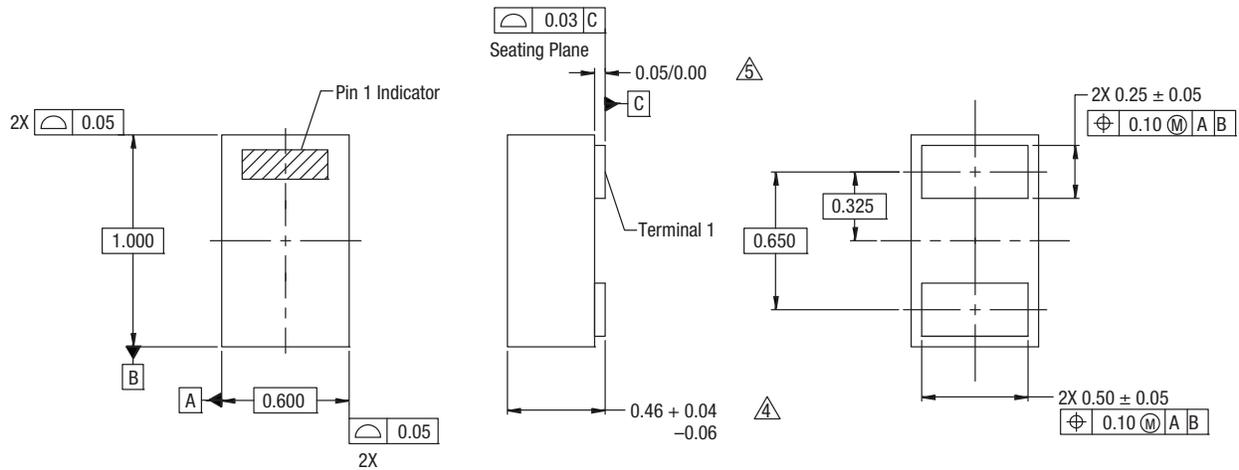
Figure 7. SC-79 Package Dimension Drawing



- Notes:
1. Carrier tape: black conductive polycarbonate or polystyrene.
 2. Cover tape material: transparent conductive PSA.
 3. Cover tape size: 5.4 mm width.
 4. ESD-surface resistivity is $< 1 \times 10^8$ Ohms/square per EIA, JEDEC TNR Specification.
 4. All measurements are in millimeters.

S2929

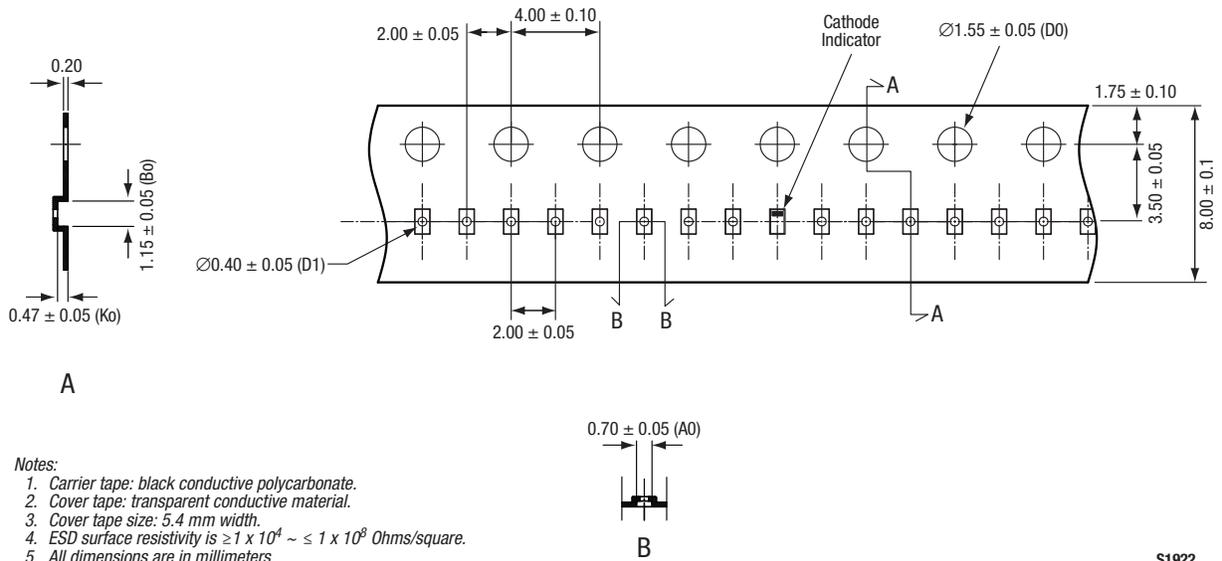
Figure 8. SC-79 Tape and Reel Dimensions



- NOTES:
1. All measurements are in millimeters.
 2. Dimensions and tolerances according to ASME Y14.5M-1994.
 3. These packages are used principally for discrete devices.
 4. This dimension includes stand-off height and package body thickness, but does not include attached features, e.g., external heatsink or chip capacitors. An integral heatslug is not considered an attached feature.
 5. This dimension is primarily terminal plating, but does not include small metal protrusion.

Y1410

Figure 11. SOD-882 Package Dimension Drawing



- Notes:
1. Carrier tape: black conductive polycarbonate.
 2. Cover tape: transparent conductive material.
 3. Cover tape size: 5.4 mm width.
 4. ESD surface resistivity is $\geq 1 \times 10^4 \sim \leq 1 \times 10^8$ Ohms/square.
 5. All dimensions are in millimeters.

S1922

Figure 12. SOD-882 Tape and Reel Dimensions

Copyright © 2009-2015 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks and the Skyworks symbol are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.